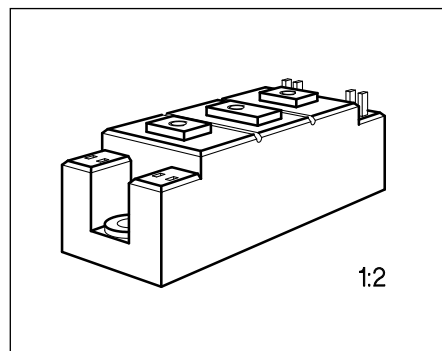


$V_{DS} = 500 \text{ V}$   
 $I_D = 2 \times 35 \text{ A}$   
 $R_{DS(on)} = 0.17 \text{ } \Omega$

- Power module
- Half-bridge
- FREDFET
- N channel
- Enhancement mode
- Package with insulated metal base plate
- Package outline/Circuit diagram: 2a<sup>1)</sup>



| Type      | Ordering Code   |
|-----------|-----------------|
| BSM 254 F | C67076-A1150-A2 |

### Maximum Ratings

| Parameter                                                    | Symbol               | Values           | Unit             |
|--------------------------------------------------------------|----------------------|------------------|------------------|
| Drain-source voltage                                         | $V_{DS}$             | 500              | V                |
| Drain-gate voltage, $R_{GS} = 20 \text{ k}\Omega$            | $V_{DGR}$            | 500              |                  |
| Gate-source voltage                                          | $V_{GS}$             | $\pm 20$         |                  |
| Continuous drain current, $T_C = 25 \text{ }^\circ\text{C}$  | $I_D$                | 35               | A                |
| Pulsed drain current, $T_C = 25 \text{ }^\circ\text{C}$      | $I_{D \text{ puls}}$ | 140              |                  |
| Operating and storage temperature range                      | $T_j, T_{stg}$       | $-55 \dots +150$ | $^\circ\text{C}$ |
| Power dissipation, $T_C = 25 \text{ }^\circ\text{C}$         | $P_{tot}$            | 400              | W                |
| Thermal resistance<br>Chip-case                              | $R_{th \text{ JC}}$  | $\leq 0.31$      | K/W              |
| Insulation test voltage <sup>2)</sup> , $t = 1 \text{ min.}$ | $V_{is}$             | 2500             | $V_{ac}$         |
| Creepage distance, drain-source                              | —                    | 16               | mm               |
| Clearance, drain-source                                      | —                    | 11               |                  |
| DIN humidity category, DIN 40 040                            | —                    | F                | —                |
| IEC climatic category, DIN IEC 68-1                          | —                    | 55/150/56        |                  |

<sup>1)</sup> See chapter Package Outline and Circuit Diagrams.

<sup>2)</sup> Insulation test voltage between drain and base plate referred to standard climate 23/50 in acc. with DIN 50 014, IEC 146, para. 492.1.

**Electrical Characteristics**at  $T_j = 25\text{ °C}$ , unless otherwise specified.

| Parameter | Symbol | Values |      |      | Unit |
|-----------|--------|--------|------|------|------|
|           |        | min.   | typ. | max. |      |

**Static Characteristics**

|                                                                                                                         |               |        |           |             |    |
|-------------------------------------------------------------------------------------------------------------------------|---------------|--------|-----------|-------------|----|
| Drain-source breakdown voltage<br>$V_{GS} = 0, I_D = 0.25\text{ mA}$                                                    | $V_{(BR)DSS}$ | 500    | —         | —           | V  |
| Gate threshold voltage<br>$V_{GS} = V_{DS}, I_D = 1\text{ mA}$                                                          | $V_{GS(th)}$  | 2.1    | 3.0       | 4.0         |    |
| Zero gate voltage drain current<br>$V_{DS} = 500\text{ V}, V_{GS} = 0$<br>$T_j = 25\text{ °C}$<br>$T_j = 125\text{ °C}$ | $I_{DSS}$     | —<br>— | 50<br>300 | 250<br>1000 | μA |
| Gate-source leakage current<br>$V_{GS} = 20\text{ V}, V_{DS} = 0$                                                       | $I_{GSS}$     | —      | 10        | 100         | nA |
| Drain-source on-state resistance<br>$V_{GS} = 10\text{ V}, I_D = 22\text{ A}$                                           | $R_{DS(on)}$  | —      | 0.14      | 0.17        | Ω  |

**Dynamic Characteristics**

|                                                                                                                                                     |              |    |      |     |    |
|-----------------------------------------------------------------------------------------------------------------------------------------------------|--------------|----|------|-----|----|
| Forward transconductance<br>$V_{DS} \geq 2 \times I_D \times R_{DS(on)max.}, I_D = 22\text{ A}$                                                     | $g_{fs}$     | 13 | 20   | —   | S  |
| Input capacitance<br>$V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$                                                                           | $C_{iss}$    | —  | 18   | 24  | nF |
| Output capacitance<br>$V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$                                                                          | $C_{oss}$    | —  | 1.3  | 1.9 |    |
| Reverse transfer capacitance<br>$V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$                                                                | $C_{rss}$    | —  | 0.48 | 0.7 |    |
| Turn-on time $t_{on} (t_{on} = t_{d(on)} + t_r)$<br>$V_{CC} = 250\text{ V}, V_{GS} = 10\text{ V}$<br>$I_D = 22\text{ A}, R_{GS} = 3.3\text{ Ω}$     | $t_{d(on)}$  | —  | 40   | —   | ns |
|                                                                                                                                                     | $t_r$        | —  | 30   | —   |    |
| Turn-off time $t_{off} (t_{off} = t_{d(off)} + t_f)$<br>$V_{CC} = 250\text{ V}, V_{GS} = 10\text{ V}$<br>$I_D = 22\text{ A}, R_{GS} = 3.3\text{ Ω}$ | $t_{d(off)}$ | —  | 70   | —   |    |
|                                                                                                                                                     | $t_f$        | —  | 55   | —   |    |

**Electrical Characteristics (cont'd)**at  $T_j = 25\text{ °C}$ , unless otherwise specified.

| Parameter | Symbol | Values |      |      | Unit |
|-----------|--------|--------|------|------|------|
|           |        | min.   | typ. | max. |      |

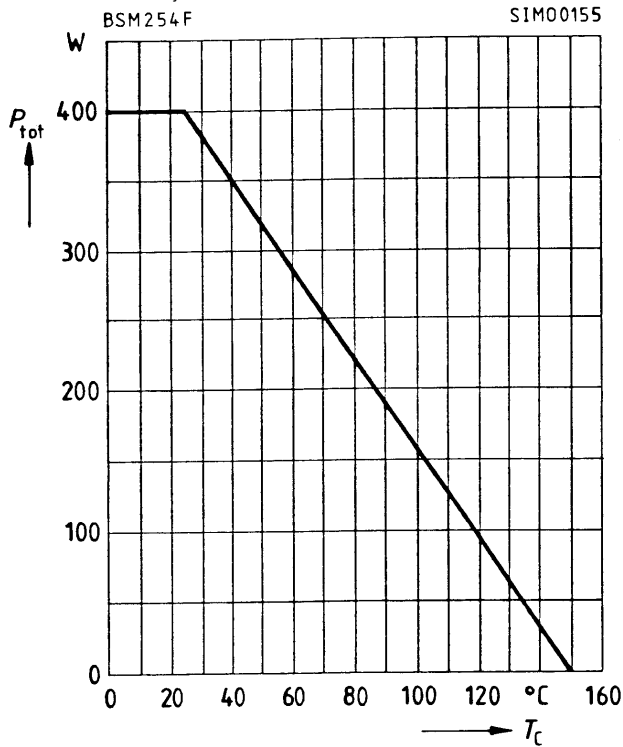
**Fast-recovery reverse diode**

|                                                                                                                                                               |           |        |            |            |               |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------|--------|------------|------------|---------------|
| Continuous reverse drain current<br>$T_C = 25\text{ °C}$                                                                                                      | $I_S$     | —      | —          | 35         | A             |
| Pulsed reverse drain current<br>$T_C = 25\text{ °C}$                                                                                                          | $I_{SM}$  | —      | —          | 140        |               |
| Diode forward on-voltage<br>$I_F = 70\text{ A}$ , $V_{GS} = 0$                                                                                                | $V_{SD}$  | —      | 1.2        | 1.6        | V             |
| Reverse recovery time<br>$I_F = I_S$ , $di_F/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 100\text{ V}$<br>$T_j = 25\text{ °C}$<br>$T_j = 150\text{ °C}$           | $t_{rr}$  | —<br>— | 200<br>350 | 280<br>500 | ns            |
| Reverse recovery charge<br>$I_F = I_S$ , $di_F/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 100\text{ V}$<br>$T_j = 25\text{ °C}$<br>$T_j = 150\text{ °C}$         | $Q_{rr}$  | —<br>— | 1.5<br>8.5 | 2.5<br>12  | $\mu\text{C}$ |
| Repetitive peak reverse current<br>$I_F = I_S$ , $di_F/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 100\text{ V}$<br>$T_j = 25\text{ °C}$<br>$T_j = 150\text{ °C}$ | $I_{RRM}$ | —<br>— | 12<br>28   | —<br>—     | A             |

Characteristics at  $T_j = 25^\circ\text{C}$ , unless otherwise specified.

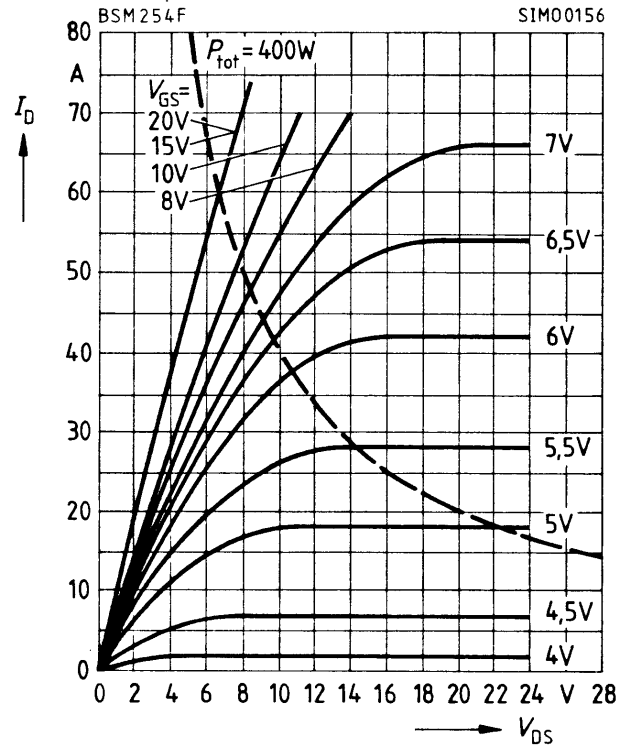
**Power dissipation**  $P_{\text{tot}} = f(T_c)$

parameter:  $T_j = 150^\circ\text{C}$



**Typ. output characteristics**  $I_D = f(V_{\text{DS}})$

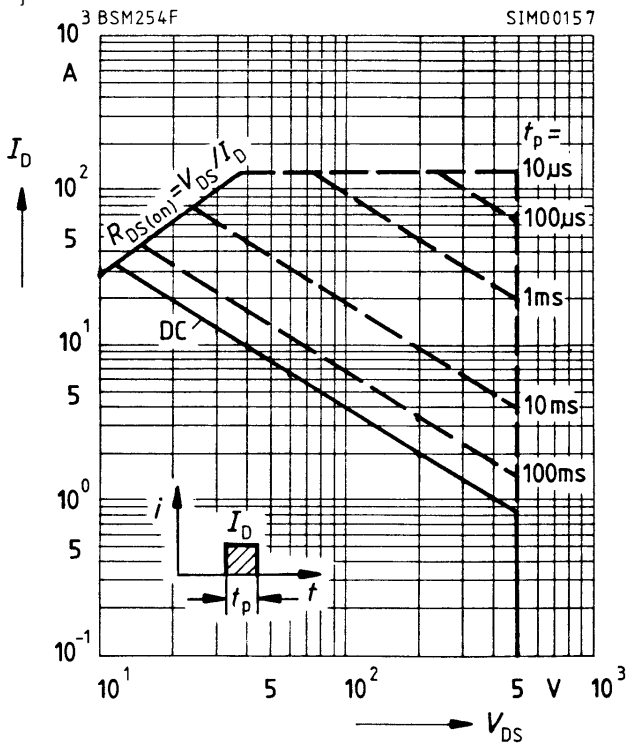
parameter:  $t_p = 80 \mu\text{s}$



**Safe operating area**  $I_D = f(V_{\text{DS}})$

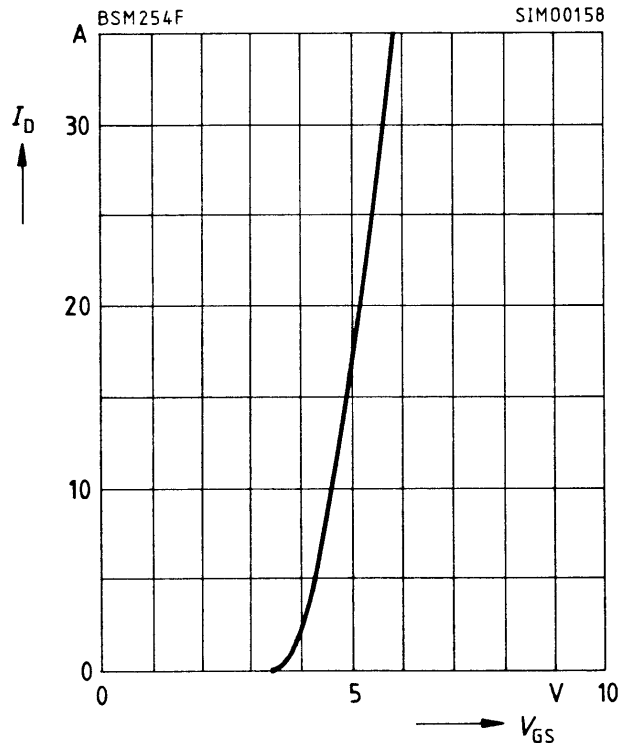
parameter: single pulse,  $T_c = 25^\circ\text{C}$

$T_j \leq 150^\circ\text{C}$

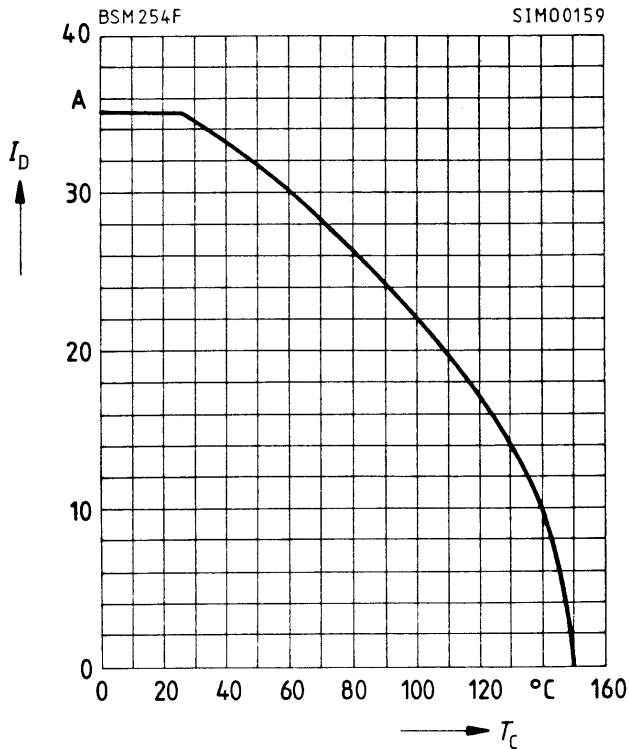


**Typ. transfer characteristic**  $I_D = f(V_{\text{GS}})$

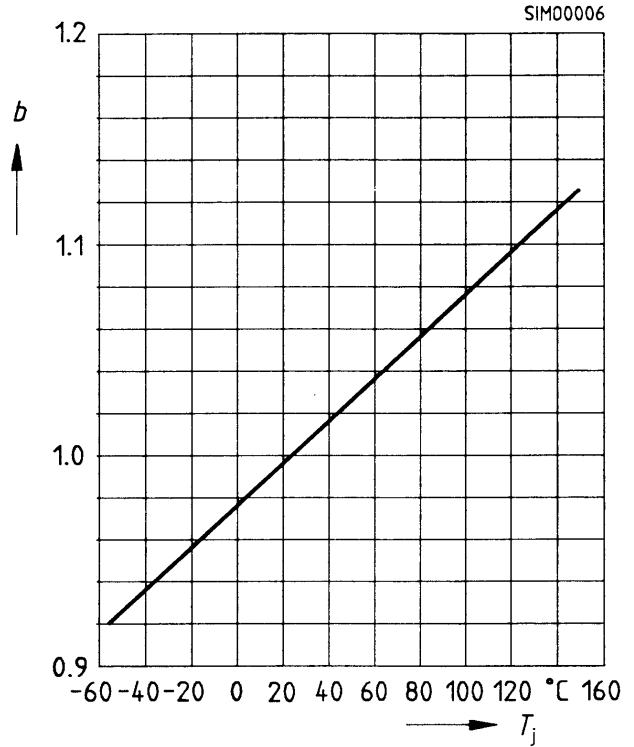
parameter:  $t_p = 80 \mu\text{s}$ ,  $V_{\text{DS}} = 25\text{V}$



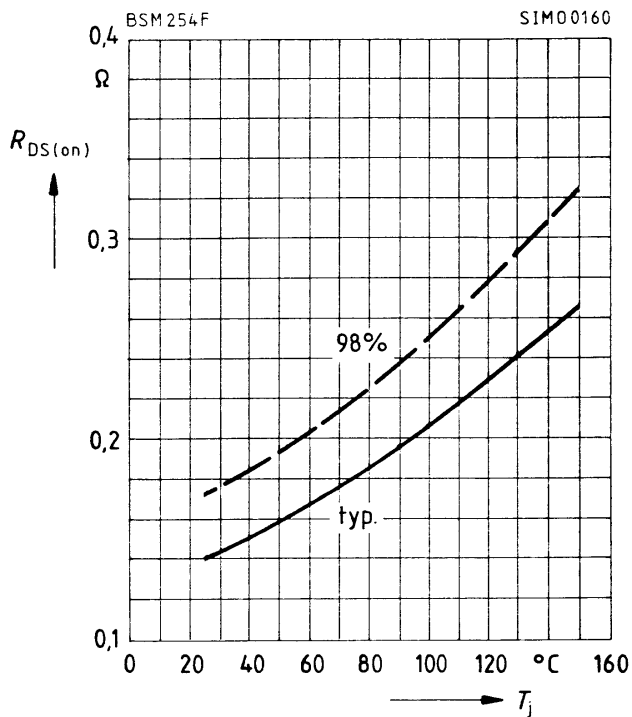
**Drain current  $I_D = f(T_C)$**   
 parameter:  $V_{GS} \geq 10 \text{ V}$ ,  $T_j = 150^\circ\text{C}$



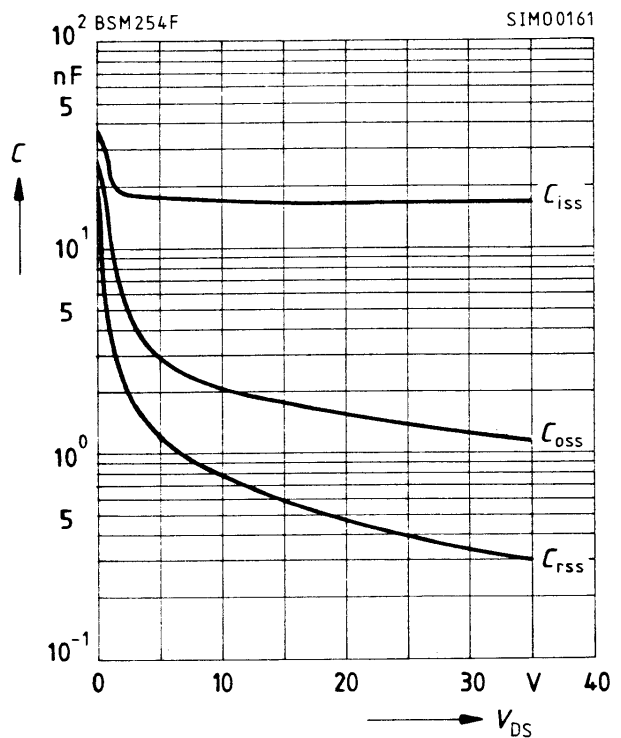
**Drain-source breakdown voltage  $V_{(BR)DSS}(T_j) = b \times V_{(BR)DSS}(25^\circ\text{C})$**



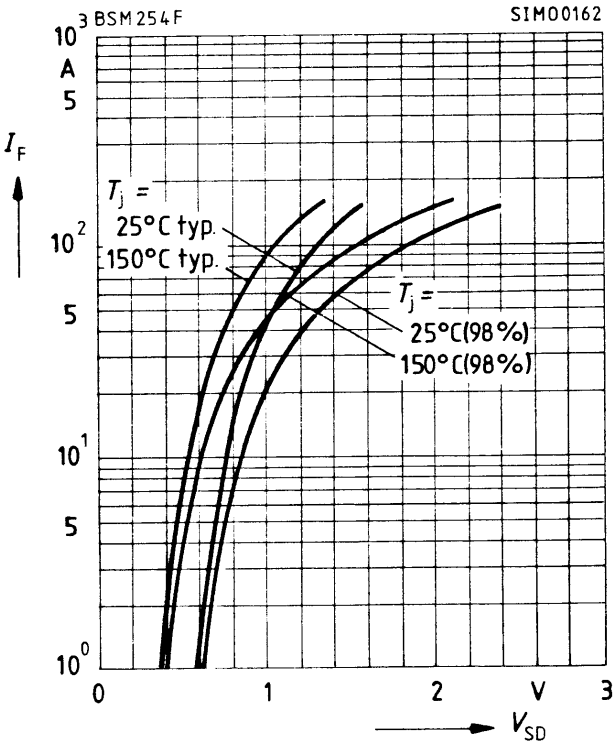
**Drain source on-state resistance  $R_{DS(on)} = f(T_j)$**   
 parameter:  $I_D = 22 \text{ A}$ ;  $V_{GS} = 10 \text{ V}$ , (spread)



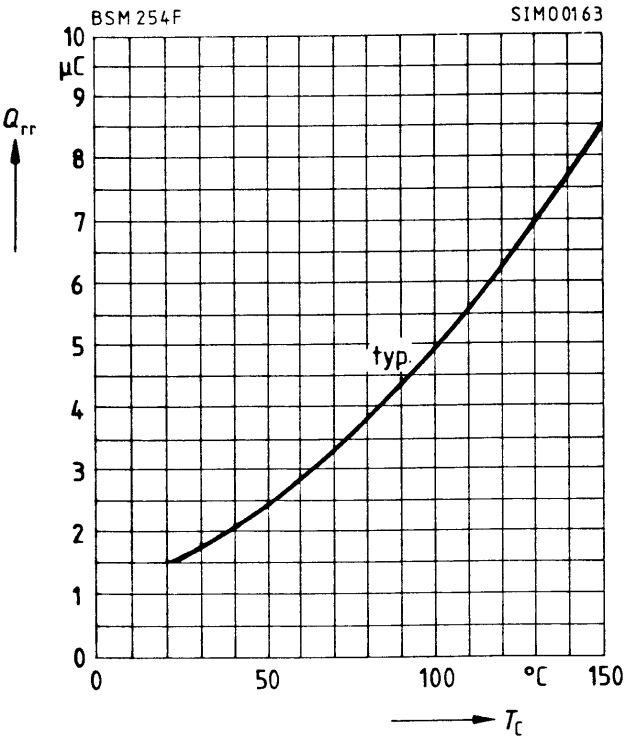
**Typ. capacitances  $C = f(V_{DS})$**   
 parameter:  $V_{GS} = 0$ ,  $f = 1 \text{ MHz}$  (spread)



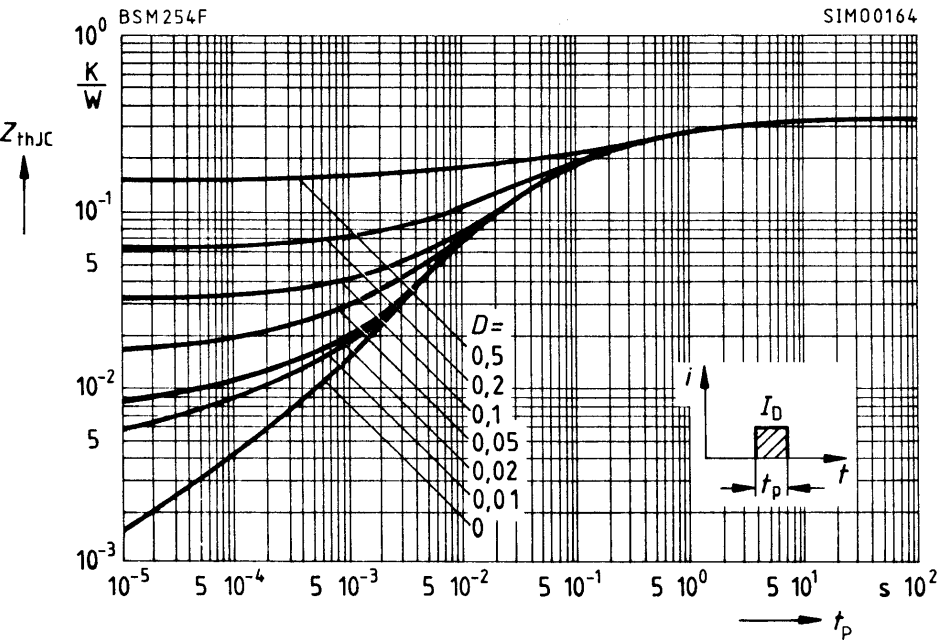
Forward characteristics  
of fast-recovery reverse diode  $I_F = f(V_{SD})$   
parameter:  $T_j, t_p = 80 \mu s$  (spread)



Typ. reverse recovery charge  $Q_{rr} = f(T_j)$   
parameter:  $di/dt = 100 A/\mu s$ ,  $I_F = 35 A$   
 $V_R = 100 V$



Transient thermal impedance  $Z_{thJC} = f(t_p)$   
parameter:  $D = t_p/T$



Typ. gate charge  $V_{GS} = f(Q_{Gate})$   
parameter:  $I_{Dpuls} = 52.5 A$

